



Atty. Dkt. No. 039153-0693 (H1718)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Xiang et al.

Title: SHALLOW TRENCH
ISOLATION PROCESS
AND STRUCTURE WITH
MINIMIZED STRAINED
SILICON CONSUMPTION

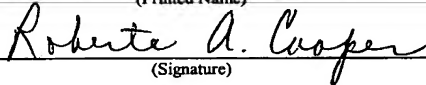
Appl. No.: 10/755,602

Filing Date: 01/12/2004

Examiner: Jack Chen

Art Unit: 2813

Confirmation No.: 9549

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| CERTIFICATE OF EXPRESS MAILING | |
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RESPONSE TO NOTICE OF NON-COMPLIANT AMENDMENT

Mail Stop AMENDMENT
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

This communication is responsive to the Notice of Non-Compliant Amendment dated October 26, 2005 concerning the above-referenced patent application.